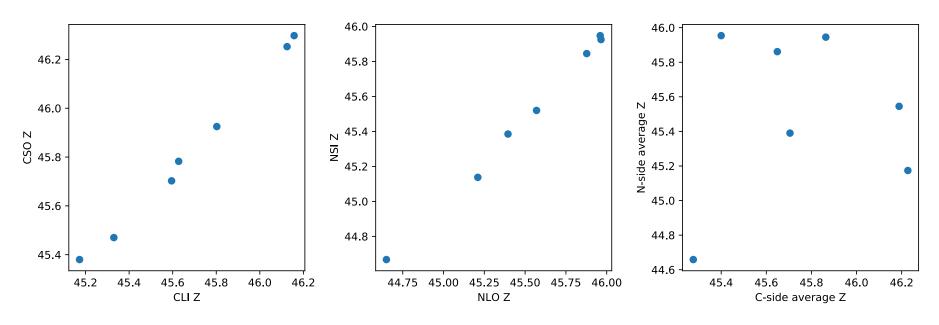
analysis of tile gluing z-positions

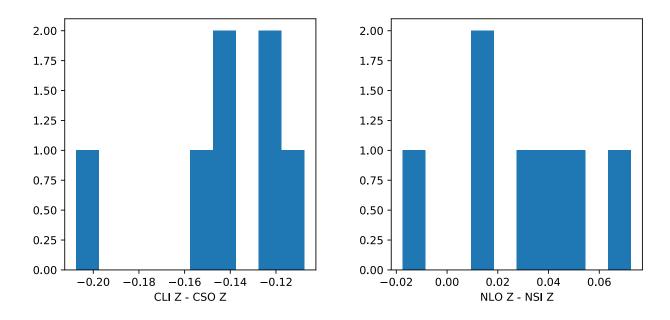
- aim: simplify the z-positioning procedure for tile gluing
- method:
 - use z-positions extracted from gluing script
 - measure average Z, deflections along X and Y, etc

average z-positions measured for different tiles



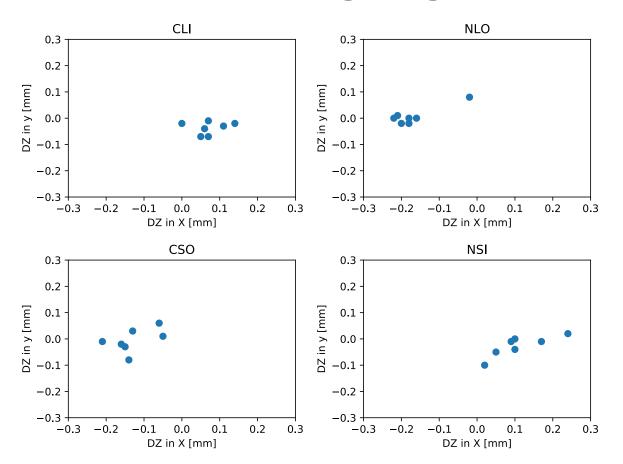
- excellent correlation between two tiles
 - → we really see large variations in needle length
- no correlation between N-side and C-side, as expected

difference in average Z between two tiles



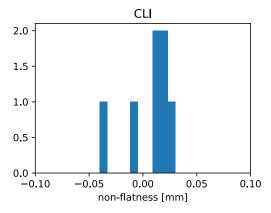
- two tiles on one side not exactly at same Z
- due to difference in pickup block thickness (?)

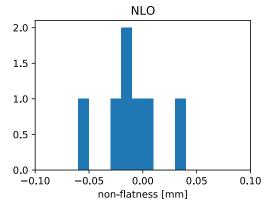
deflections along long side X and short side Y

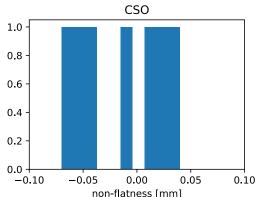


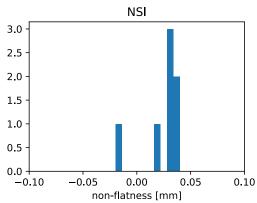
- DZ in y = beam bond
 DZ in x = right left
- NLO and CSO are tilted in x direction
- NSI has large variations: difficult to believe that these are real

do tiles look flat?









- measure 'warping': (z_beam_left+z_bond_right - z_beam_right-z_bond_left)
- we believe that tiles are flat, so this is a measure for how well we measure

plan

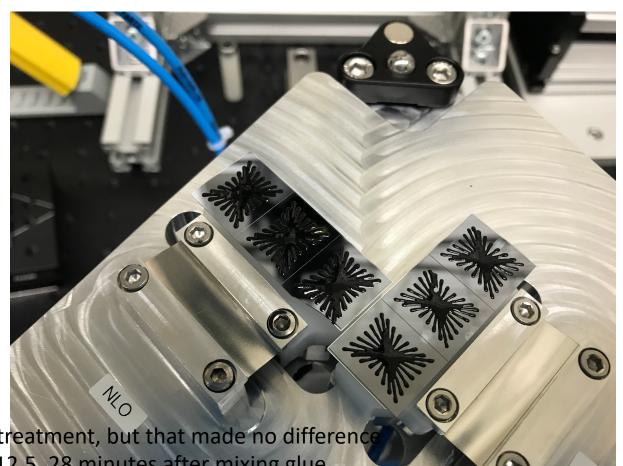
- plan
 - measure deflections of tiles on pickup blocks using the pick and place machine
 - use these in the gluing program
 - for z-positioning, just measure 1 point per tile, right in the middle

glue beading test

- samples (in this order)
 - 3 ASICs plasma cleaned
 - 3 ASICs uncleaned
 - 1 tile plasma cleaned (and isopropanol and xxx)
 - 1 tile not plasma cleaned
 - 2 ASICs plasma cleaned, 1 not cleaned

real tiles

cleaned, no beading



uncleaned, a little beading?

after heat treatment, but that made no difference linespeed 12.5, 28 minutes after mixing glue

what went where?